



## P-Channel Enhancement-Mode Vertical DMOS FETs

### Ordering Information

$BV_{DSS}$ / $BV_{DGS}$	$R_{DS(ON)}$ (max)	$I_{D(ON)}$ (min)	$V_{GS(th)}$ (max)	Order Number / Package		
				TO-39	TO-92	TO-220
-60V	3.5Ω	-1.5A	-2.4V	—	TP0606N3	TP0606N5
-100V	3.5Ω	-1.5A	-2.4V	TP0610N2	TP0610N3	—

\* 14 pin side brazed ceramic DIP

\*\* 14-pin plastic DIP

### High Reliability Devices

See pages 5-4 and 5-5 for MILITARY STANDARD Process Flows and Ordering Information.

### Features

- Low threshold — -2.4V max
- High input impedance
- Low input capacitance — 80pF typical
- Fast switching speeds
- Low on resistance
- Free from secondary breakdown
- Low input and output leakage
- Complementary N- and P-channel devices

### Applications

- Logic level interfaces – ideal for TTL and CMOS
- Solid state relays
- Battery operated systems
- Photo voltaic drives
- Analog switches
- General purpose line drivers
- Telecom switches

### Absolute Maximum Ratings

Drain-to-Source Voltage	$BV_{DSS}$
Drain-to-Gate Voltage	$BV_{DGS}$
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

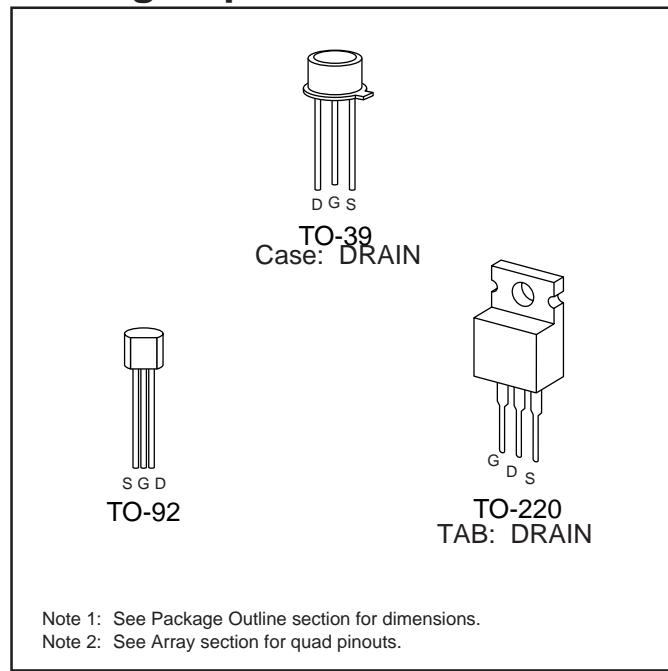
\* Distance of 1.6 mm from case for 10 seconds.

### Low Threshold DMOS Technology

These low threshold enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

### Package Options



## Thermal Characteristics

Package	$I_D$ (continuous)*	$I_D$ (pulsed)	Power Dissipation @ $T_C = 25^\circ\text{C}$	$\theta_{jc}$ °C/W	$\theta_{ja}$ °C/W	$I_{DR}^*$	$I_{DRM}$
TO-39	-1.0A	-4.0A	6W	20.8	125	-1.0A	-4.0A
TO-92	-0.5A	-3.5A	1W	125	170	-0.5A	-3.5A
TO-220	-2.0A	-4.5A	45W	2.7	70	-2.0A	-4.5A

\*  $I_D$  (continuous) is limited by max rated  $T_j$ .

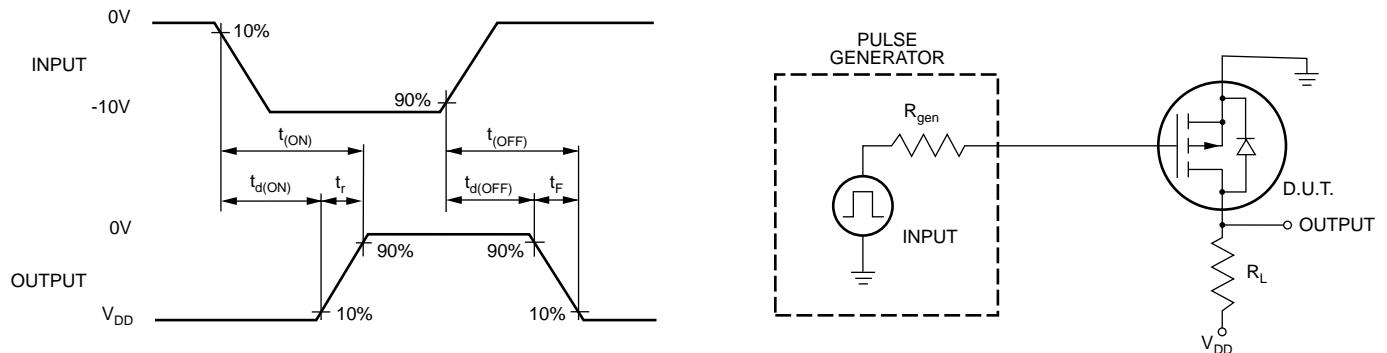
## Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
$BV_{DSS}$	Drain-to-Source Breakdown Voltage	TP0610	-100		V	$V_{GS} = 0V, I_D = -2.0\text{mA}$
		TP0606	-60			
$V_{GS(\text{th})}$	Gate Threshold Voltage	-1.0		-2.4	V	$V_{GS} = V_{DS}, I_D = -1.0\text{mA}$
$\Delta V_{GS(\text{th})}$	Change in $V_{GS(\text{th})}$ with Temperature			-5.0	mV/°C	$V_{GS} = V_{DS}, I_D = -1.0\text{mA}$
$I_{GSS}$	Gate Body Leakage			-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
$I_{DSS}$	Zero Gate Voltage Drain Current			-10	$\mu\text{A}$	$V_{GS} = 0V, V_{DS} = \text{Max Rating}$
				-1.0	mA	$V_{GS} = 0V, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{D(\text{ON})}$	ON-State Drain Current	-0.4	-0.6		A	$V_{GS} = -5V, V_{DS} = -25V$
		-1.5	-2.5			$V_{GS} = -10V, V_{DS} = -25V$
$R_{DS(\text{ON})}$	Static Drain-to-Source ON-State Resistance		5.0	7.0	$\Omega$	$V_{GS} = -5V, I_D = -250\text{mA}$
			3.0	3.5		$V_{GS} = -10V, I_D = -0.75A$
$\Delta R_{DS(\text{ON})}$	Change in $R_{DS(\text{ON})}$ with Temperature			1.7	%/°C	$V_{GS} = -10V, I_D = -0.75A$
$G_{FS}$	Forward Transconductance	300	400		$\text{m}\Omega$	$V_{DS} = -25V, I_D = -0.75A$
$C_{ISS}$	Input Capacitance		80	150	pF	$V_{GS} = 0V, V_{DS} = -25V$ $f = 1 \text{ MHz}$
$C_{OSS}$	Common Source Output Capacitance		50	85		
$C_{RSS}$	Reverse Transfer Capacitance		15	35		
$t_{d(\text{ON})}$	Turn-ON Delay Time			10	ns	$V_{DD} = -25V$ $I_D = -1.0A$ $R_{\text{GEN}} = 25\Omega$
$t_r$	Rise Time			15		
$t_{d(\text{OFF})}$	Turn-OFF Delay Time			20		
$t_f$	Fall Time			15		
$V_{SD}$	Diode Forward Voltage Drop			-1.8	V	$V_{GS} = 0V, I_{SD} = -1.0A$
$t_{rr}$	Reverse Recovery Time		300		ns	$V_{GS} = 0V, I_{SD} = -1.0A$

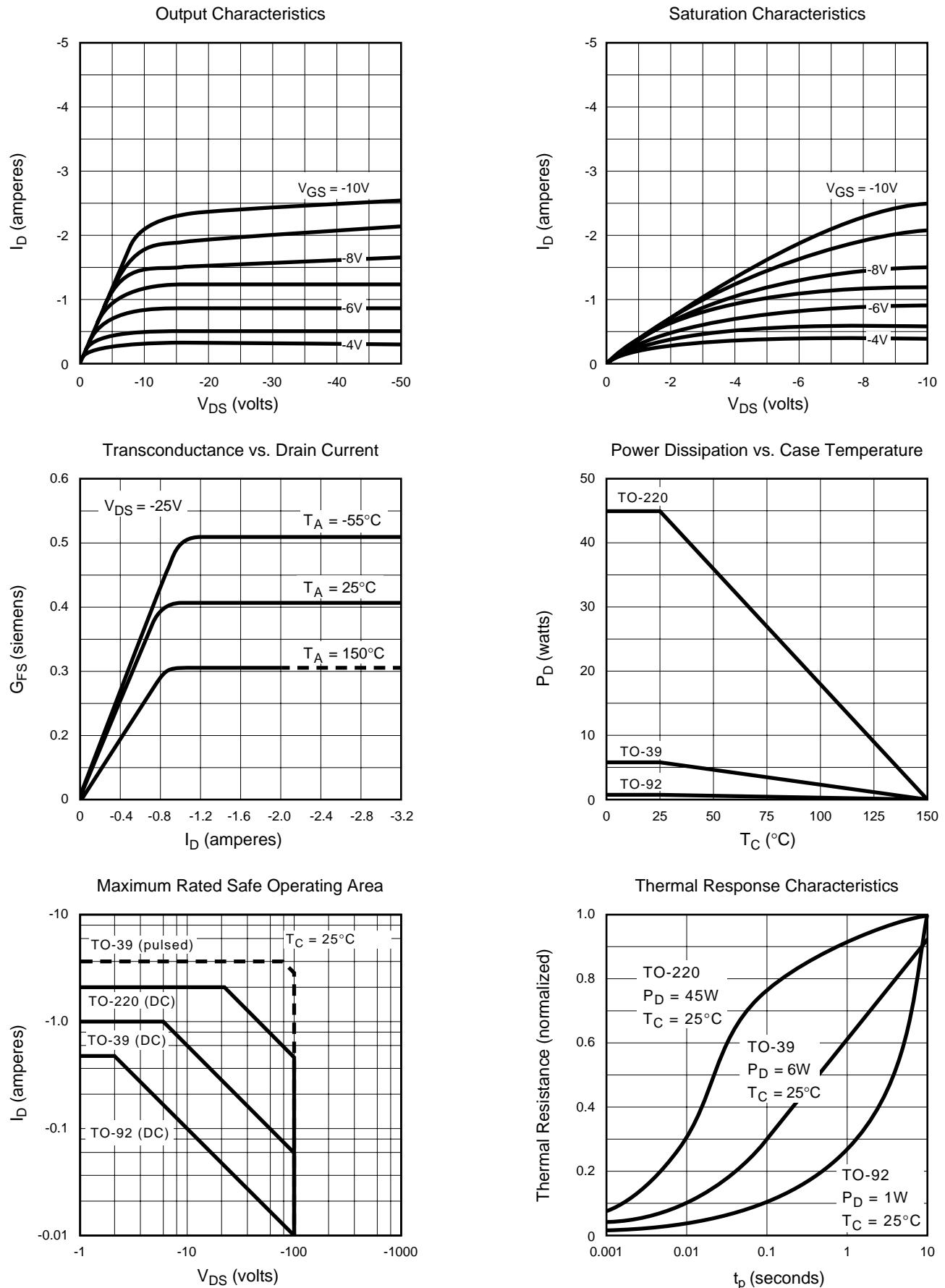
### Notes:

- All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300μs pulse, 2% duty cycle.)
- All A.C. parameters sample tested.

## Switching Waveforms and Test Circuit



# Typical Performance Curves



## Typical Performance Curves

